

DIGITRON SEMICONDUCTORS

MCR264-4 – MCR264-12

THYRISTORS
SILICON CONTROLLED RECTIFIERS

Available Non-RoHS (standard) or RoHS compliant (add PBF suffix).

Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Forward and Reverse Blocking Voltage ⁽¹⁾ ($T_J = 25$ to 125°C , Gate Open)	V_{DRM} V_{RRM}	200	Volts	
		MCR264-4		400
		MCR264-6		600
		MCR264-8		800
		MCR264-10		1000
Forward Current ($T_C = 80^\circ\text{C}$) (All Conduction Angles)	$I_{\text{T(RMS)}}$ $I_{\text{T(AV)}}$	40	Amps	
		25		
Peak Non-Repetitive Surge Current – 8.3ms (1/2 Cycle, Sine Wave) 1.5ms	I_{TSM}	400	Amps	
		450		
Forward Peak Gate Power	P_{GM}	20	Watts	
Forward Average Gate Power	$P_{\text{G(AV)}}$	0.5	Watt	
Forward Peak Gate Current (300 μs , 120PPS)	I_{GM}	2	Amps	
Operating Junction Temperature Range	T_J	-40 to +125	$^\circ\text{C}$	
Storage Temperature Range	T_{stg}	-40 to +150	$^\circ\text{C}$	

- V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded. These devices are rated for use in applications subject to high surge conditions. Care must be taken to ensure proper heat sinking when the device is to be used at high sustained currents.

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta\text{JC}}$	1	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient	$R_{\theta\text{JA}}$	60	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristics	Symbol	Min	Typ	Max	Unit
Peak Forward or Reverse Blocking Current ($V_{\text{AK}} = \text{Rated } V_{\text{DRM}}$ or V_{RRM} , Gate Open)	$I_{\text{DRM}}, I_{\text{RRM}}$	$T_J = 25^\circ\text{C}$	-	-	10 μA
		$T_J = 125^\circ\text{C}$	-	-	2 mA
Forward "On" Voltage ⁽¹⁾ ($I_{\text{TM}} = 80\text{A}$)	V_{TM}	-	1.4	2	Volts
Gate Trigger Current (Continuous dc) (Anode Voltage = 12 Vdc, $R_L = 100$ Ohms, $T_C = -40^\circ\text{C}$)	I_{GT}	-	15	50	mA
		-	30	90	
Gate Trigger Voltage (Continuous dc) (Anode Voltage = 12 Vdc, $R_L = 100$ Ohms)	V_{GT}	-	1	1.5	Volts
Gate Non-Trigger Voltage (Anode Voltage = Rated V_{DRM} , $R_L = 100$ Ohms, $T_J = 125^\circ\text{C}$)	V_{GD}	0.2	-	-	Volts
Holding Current (Anode Voltage = 12 Vdc)	I_{H}	-	30	60	mA
Turn-On Time ($I_{\text{TM}} = 40$ A, $I_{\text{GT}} = 60$ mAdc)	t_{gt}	-	1.5	-	μs
Critical Rate-of-Rise of Off-State Voltage (Gate Open, $V_D = \text{Rated } V_{\text{DRM}}$, Exponential Waveform)	dv/dt	-	50	-	$\text{V}/\mu\text{s}$

- Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

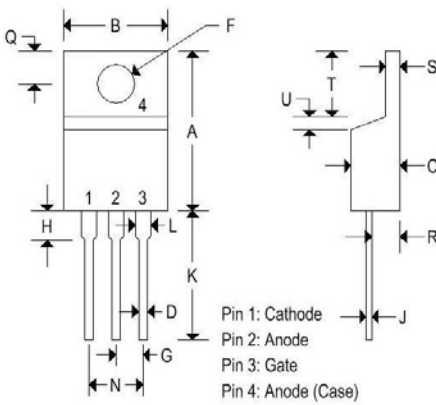
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MECHANICAL CHARACTERISTICS

Case	TO-220AB
Marking	Alpha-numeric
Pin out	See below



	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

FIGURE 1 — AVERAGE CURRENT DERATING

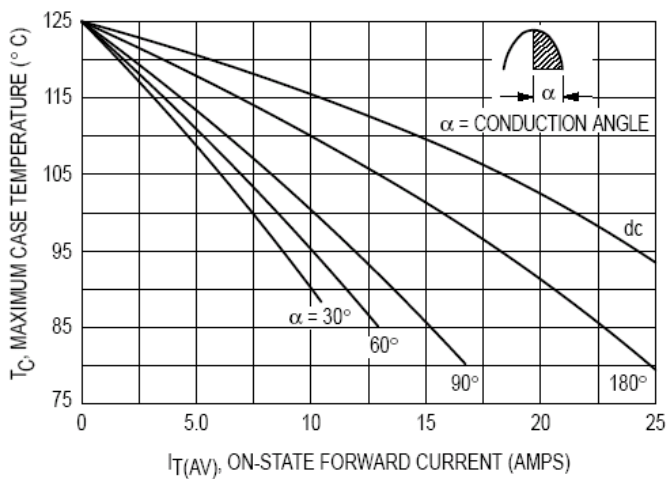
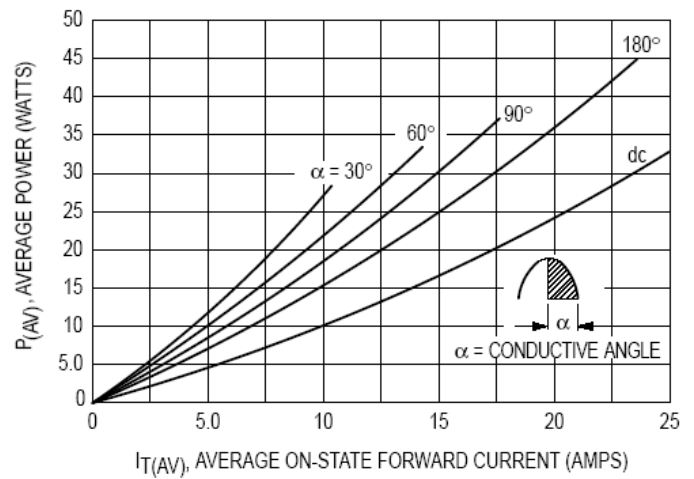


FIGURE 2 — MAXIMUM ON-STATE POWER DISSIPATION



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FIGURE 3 — GATE TRIGGER CURRENT

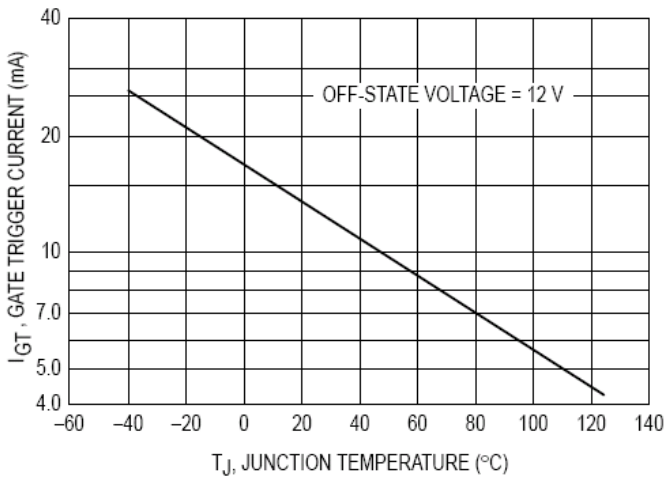


FIGURE 4 — NEW GATE TRIGGER VOLTAGE

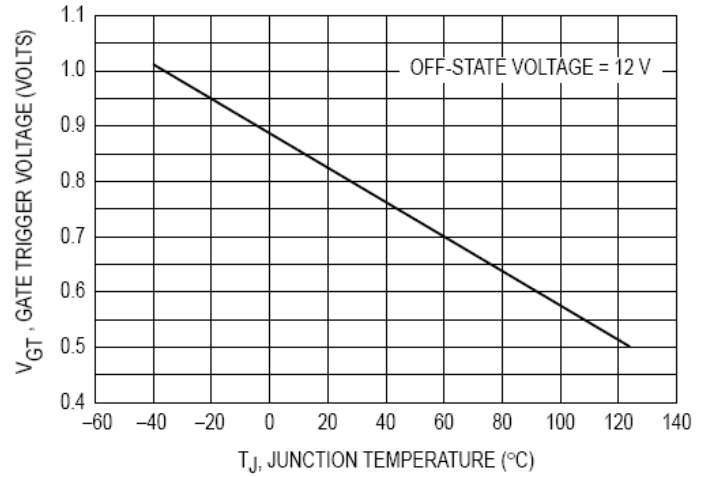


FIGURE 5 — HOLDING CURRENT

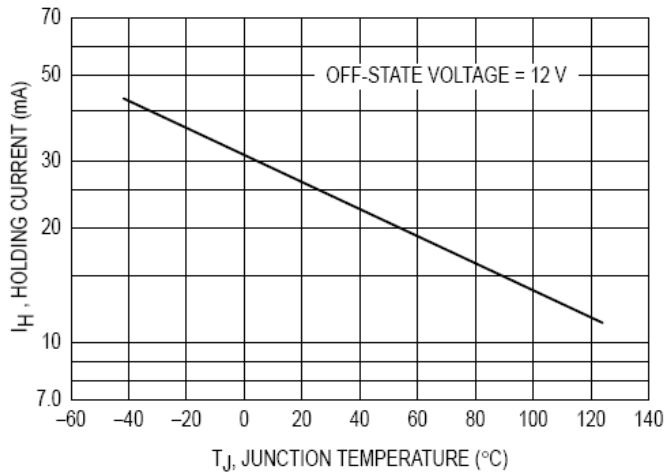


FIGURE 6 — TYPICAL FORWARD VOLTAGE

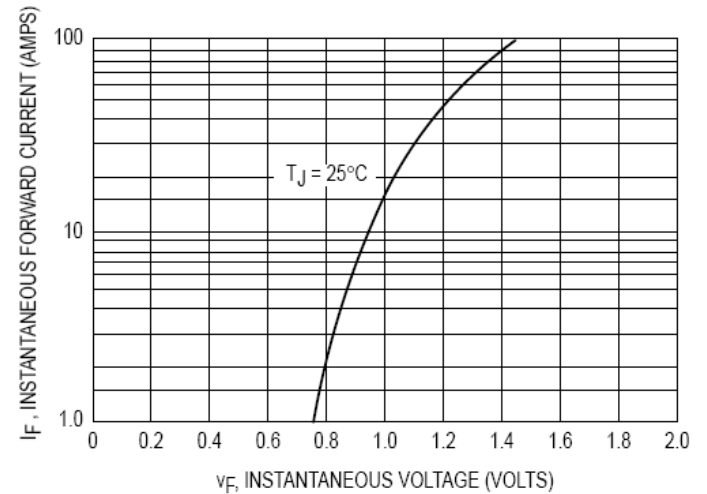


FIGURE 7 — THERMAL RESPONSE

